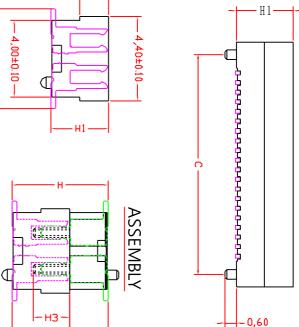
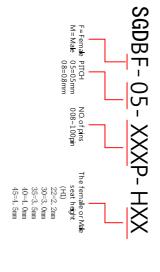


-01.0±05/g-



Ordering Information



日期 单位

14.08.30 -:

0000

±0.05 ±0.10

深圳市山谷道电子有限公司 SHENZHEN SHANGUDAO ELECTRONIC CO., LTD

±0,5 >

物料编号 SGDBF-05-***P-H**

z z

尺寸公差

审核 校对 绘制 比例

视角 英英

4

包装规格

卷带1000PCS/R

图号

品名

0.5mm BOARD TO BOARD 母座 双槽

立贴式 xx001

$D \pm 0.1$	$C \pm 0.10$	Contacts A±0.10 B±0.10 C±0.10 D±0.1	Contacts A±(
	Dimension(mm)	Dimens	NO. of
	(,	
	d Plating	Contact:phosphor Bronae,Gold Plating:	Contact:phosph
			Material:PA9T
		r Alloy	Terminal:Copper Alloy
			UL94V-0
	stic	Housing: High Temperature Plastic	Housing:High T
			Materirls
	85°C	Operting Temperature: -40°C +85°C	Operting Temp
			AC r.m.s
	age:200V	Dlelectric Withstanding Voltage: 200V	Dlelectric Wi
	min	Insulation Resistance:100 MΩ min	Insulation Res
		ance:50mΩ Max	Contact Resistance: 50m \Omega Max
	S	Current Rating: 0.5A AC(rms)/DC	Current Ratin
		50V AC (rms)/DC	Vlotag Rating: 50V AC(rms)/DC

Electrical:

25. 48	26. 40	24. 50	27. 70	100
20.48	21.40	19. 50	22. 70	80
	18. 90	17. 00	20. 20	70
15. 48	16.40	14. 50	17. 70	60
	14.40	12. 50	15. 70	52
ı	13. 90	12.00	15. 20	50
12. 48				48
11. 98	12. 90	11.00	14. 20	46
11.48	12.40	10.50	13. 70	44
				42
10.48	11.40	9.50	12. 70	40
9.48	10.40	8. 50	11.70	36
8. 98	9.90	8.00	11. 20	34
8.48	9.40			32
				30
	8.40	6. 50	9.70	28
	7.90	6.00		26
6.48	7.40	5. 50	8. 70	24
	6.90			22
	6.40	4.50	7.70	20
4.98	5.90	4.00	7.20	18
4.48				16
3.98	4.90	3.00		14
3. 48	4.40	2.50		12
2. 98	3.90	2.00	5. 20	10
2.48	3.40	1.50		8
$D \pm 0.10$	$C \pm 0.10$	$B \pm 0.10$	$A\pm0.10$	Contacts
	ion(mm)	Dimens		NO. of
	d rating,	ronae, dord	phosphot pi	- Contract.bi
		S	hor R	da. +2 +4 +40
				_ :
		OV	Copper Allov	_
				UL94V→0
	stic	ature Plastic	gh Temperature	Housing:High
				Materirls
	_+85°C	−40°C	Temperature:	Operting
	G G			
	Woltage: 200V		c Withstanding	Insulation Dielectric
			- 0	T 1
	>		Nating. O. JA	
	3) + : p \(\tau \) \(\tau \)	